WIELH

HTE9G04P2K0H(B) 2000W, 1-400 MHz LDMOS Amplifier

Product datasheet

Description

The HTE9G04P2K0H(B) is high ruggedness device designed for use in high VSWR ISM, Broadcast and Mobile Radio applications. It's unmatched Input/Output design supports frequency use from 1 to 400 MHz

Features

• Operating Frequency Range: 1 -400 MHz

• Operating Drain Voltage: 65V

Saturation Output Power: 2000W

 Excellent thermal stability due to low thermal resistance package

 Enhanced robustness design without device degradation

• Internally integrated enhanced ESD design

High Breakdown voltage

Applications

- Industrial Scientific Medical (ISM)
 - Laser generation
 - Plasma generation
 - Particle accelerators
 - MRI, RF ablation and skin treatment
 - Industrial heating, welding and drying systems

Ordering Information

Part Number	Description	
HTE9G04P2K0H(B)	Tray Package	
HTE9G04P2K0H(B) EVB	13.56MHz EVB	



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Typical Performance

RF Characteristics (Pulsed-CW)

Freq(MHz)	Vdd (V)	Gain (dB)	Pout(dBm)	Pout(W)	Eff (%)
13.56	55	29.53	62.55	1800	82
60	65	29.23	63.23	2100	85
123-133	62	29.30	62.84	1900	68
128	65	27.30	63.05	2000	78
170	65	29.11	61.76	1500	81

Test conditions unless otherwise noted: 25 $^{\circ}$ C (Indirect water cooling), IDQ= 100mA, PW = 100us, Duty Cycle = 10% test on WATECH Application Board

RF Characteristics (CW)

Freq(MHz)	Vdd (V)	Gain (dB)	Pout(dBm)	Pout(W)	Eff (%)
13.56	55	29.68	62.33	1700	79
60	65	30.10	62.84	1900	83
170	65	29.40	61.51	1400	78

Test conditions unless otherwise noted: 25 $^{\circ}$ C (Indirect water cooling), IDQ= 100mA, PW = 1ms, test on WATECH Application Board

Absolute Maximum Ratings

Parameter	Range/Value	Unit
Drain voltage (VDSS)	-0.5 to +190	V
Gate voltage (V _{GS})	-5 to +10	V
Storage Temperature (Tstg)	-55 to +150	°C
Junction Temperature (T _J)	+225	°C

Electrical Specification

DC Characteristics

Parameter	Conditions	Min	Тур	Max	Unit
Breakdown Voltage V(BR)DSS	Vgs=0V, Ids=619.2uA	203	208	-	V
Gate-Source Threshold	\/gs=\/ds_\ds_\610_2\\A	2.3	2.8	3.1	V
Voltage V _{GS(th)}	Vgs=Vds, Ids=619.2uA				V
Drain Leakage Current IDSS	Vgs=0V, Vds=65V	-	0.4	-	uA
Gate Leakage Current IGSS	Vgs=5V, Vds=0V	-	0.4	-	uA



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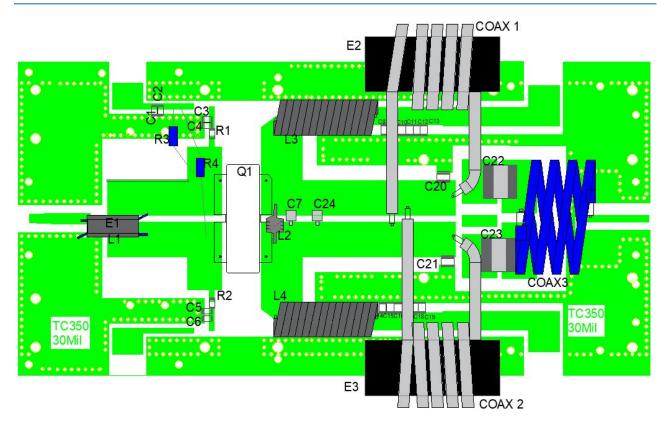
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Condition	Test Result
VSWR=65:1; V_{DS} = 65 V; I_{Dq} = 100 mA per section; P_L = 2000 W pulsed; t_p = 100	No Device
us; δ= 10 %; Frequency=60MHz test on WATECH Application Board	Degradation

Thermal Information

Parameter	Condition	Value (Typ)	Unit
Thermal Resistance	Tj=95°C,VDD=65V,IDQ=6.75A,measured	0.123	°C /W
Junction to Case (Rтн)	under DC condition	0.125	C/W

HTE9G04P2K0H(B) 13.56MHz Reference Design



EVB Layout

Bill of Materials (BoM) - HTE9G04P2K0H(B) 13.56 MHz Reference Design

Reference	Value	Description	Manufacturer	P/N
Q1		LDMOS transistor	WATECH	HTE9G04P2K0H(B)
C1 C4 C5 C9 C10 C15 C16	10 nF	1210 Chip Capacitor	Murata	GRM31CR71H103KA12L
C2 C3 C6 C12	10 μF	1210 Chip Capacitor	Murata	GRM31CR71H106KA12L

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AAFIF				Product datasheet
C13 C18 C19				
C7 C24	150pF	1210 Chip Capacitor	CDE	MIN02-002EC151J-F
C8 C14	220pF	1111 Chip Capacitor	Beijing YuanLu Hong Yuan Electronic Tech nology Co.,LTD	MQ101111M7G3A221JNMB
C11 C17	2.2μF	2525 Chip Capacitor	Murata	GRM31CR71H225KA12L
C20 C21	1nF	2525 Chip Capacitor	Beijing YuanLu Hong Yuan Electronic Tech nology Co.,LTD	MQ102525M7G3D102JNLC
C22 C23	5.1nF	3838 Chip Capacitor	Beijing YuanLu Hong Yuan Electronic Tech nology Co.,LTD	MQ103838M7G2H512KNNC
L1	2 turns	Air Inductor	0.8mm copper wire	
L2	3 turns,d = 10 mm	Air Inductor	2mm copper wire	
L3 L4	10 turns,d =10 mm	Air Inductor	2mm copper wire	
E1	#43	Multi-Aperture Core	Fair-Rite	
E2 E3	28.6*26*12.7		Beijing Seven Star Fight Electronic Technology Co.,LTD	
COAX1 COAX2	16.70hm SR Coax, 5turns 650mm	9:1	-	
COAX3	500hm SR Coax, 4turns 500mm	2:1	-	
R1 R2	51Ω	1206 Chip Resistor	КОА	
R3 R4	1KOhm, WireResistors	-	-	
РСВ	20mil Thickness			Rogers4350B

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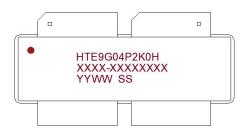
Performance Plots

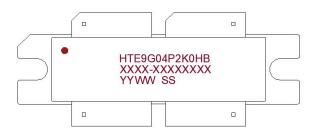


CW, Gain and Efficiency vs Pout

Test conditions unless otherwise noted: 25 °C, VDD = +55Vdc, IDQ= 100mA CW test on WATECH Application Board

Package Marking and Dimensions





- Line1 (fixed): Device name in work order
- Line2 (unfixed): Mark Lot number in work order (Sample: E596-20140001)
- Line3 (unfixed): Date Code + "SS" (The last two digits of sub lot Number)

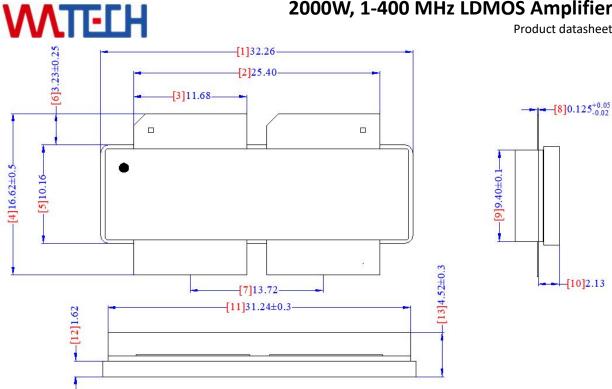
This Marking SPEC only stipulates the content of Marking. For marking requirements such as font and size, please refer to the latest version of "Watech Product Printing Specification"

Marking

HTE9G04P2K0H(B)

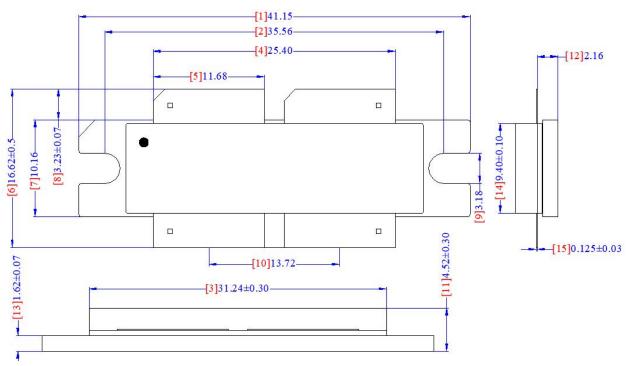
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Remark: 1.Unit: mm; 2.Unlabeled tolerance is ± 0.13 mm.

ACC3210S-4L; Earless Flanged Balanced Air Cavity Ceramic Package; 4 Leads



Remark: 1.Unit: mm; 2.Unlabeled tolerance is ± 0.13 mm.

ACC3210B-4L; Flanged Balanced Air Cavity Ceramic Package; 2 Mounting holes, 4 Leads **Package Dimensions**

HTE9G04P2K0H(B) 2000W, 1-400 MHz LDMOS Amplifier

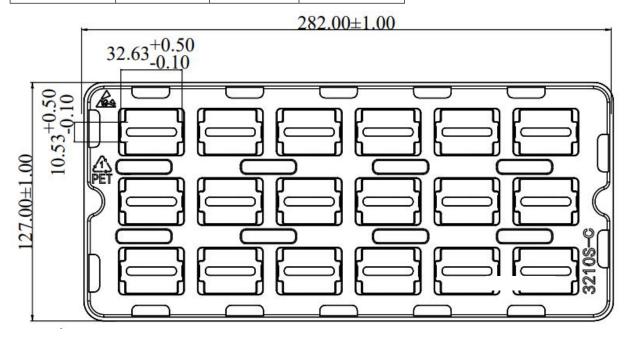


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Packaging Information

HTE9G04P2K0H:

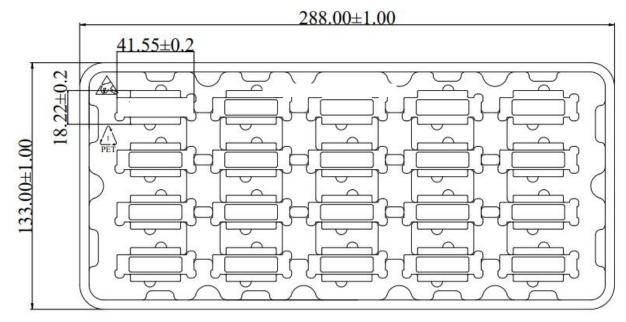
Package Type	Qty/Tray(pcs)	Qty/Box(pcs)	Qty/Carton(pcs)
ACC3210S-4L	18	90	540



Packaging Descriptions

HTE9G04P2K0HB:

Package Ty	/pe Qty/Ti	ray(pcs) Qty/Bo	ox(pcs) Qty/Carto	n(pcs)
ACC3210B	-4L 2	20 10	00 600	



Packaging Descriptions



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Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1B	JESD22-A114
ECD Human Body Model (MMA)	Class A	EIA/IECD22 A11E



ESD – Human Body Model (MM) Class A EIA/JESD22-A115 ESD – Charged Device Model (CDM) Class III JESD22-C101

RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU.

Datasheet Status

Document status	Product status	Definition	
Objective Datasheet	Design simulation	Product objective specification	
Preliminary Datasheet	Customer sample	Engineering samples and first test results	
Product Datasheet	Mass production	Final product specification	

Abbreviations

Acronym	Definition	
LDMOS	Laterally-Diffused Metal-Oxide Semiconductor	
CW	Continuous Waveform	
VSWR	Voltage Standing Wave Ratio	

Revision history

Document ID	Datasheet Status	Release Date	Revision Version
Rev 0.1	Objective	Oct. 2023	Objective
Rev 1.0	Preliminary	Jan.2024	Preliminary
Rev 1.1	Preliminary	Apr.2024	Update TBD information
Rev 2.0	Product	Jun.2024	Product Version

WATELH Contact Information

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For the latest specifications, additional product information, worldwide sales and distribution locations and information about WATECH:

• Web: <u>www.watechelectronics.com</u>

• Email: MKT@huatai-elec.com

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